TOSHIBA Field Effect Transistor Silicon N-Channel MOS Type (π-MOSV)

2SK3437

DC-DC Converter, Relay Drive and Motor Drive Applications

- Low drain-source ON-resistance: $R_{DS (ON)} = 0.74 \Omega (typ.)$
- High forward transfer admittance: |Y_{fs}| = 4.5 S (typ.)
- Low leakage current: I_{DSS} = 100 μA (max) (V_{DS} = 600 V)
- Enhancement mode: V_{th} = 3.0 to 5.0 V (V_{DS} = 10 V, I_D = 1 mA)

Absolute Maximum Ratings (Ta = 25°C)

Characteristics		Symbol	Rating	Unit	
Drain-source voltage		V_{DSS}	600	(\sqrt{y})	
Drain-gate voltage ($R_{GS} = 20 \text{ k}\Omega$)		V_{DGR}	600	V	
Gate-source voltage		V_{GSS}	±30	V	
Drain current	DC (Note 1)	ΙD	10	\supset	
	Pulse (Note 1)	I _{DP}	30	Α	
Drain power dissipation ((Tc = 25°C)	P _D	80	W	
Single pulse avalanche e	energy (Note 2)	E _{AS}	252	mJ mJ	
Avalanche current		IAR)) 10	Α	
Repetitive avalanche ene	EAR	8 <	\ mJ		
Channel temperature	(T _{ch})	150	7,¢¢		
Storage temperature ran	ge	Tstg	-55 to 150	\~c	

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings. Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Thermal Characteristics

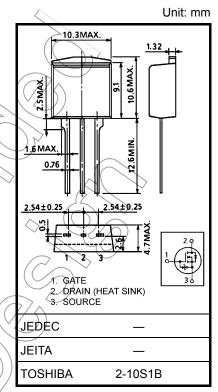
Characteristics	Symbol	Max	Unit
Thermal resistance, channel to case	R _{th (ch-c)}	1.56	°C/W
Thermal resistance, channel to ambient	R _{th (ch-a)}	83.3	°C/W

Note 1: Ensure that the channel temperature does not exceed 150°C.

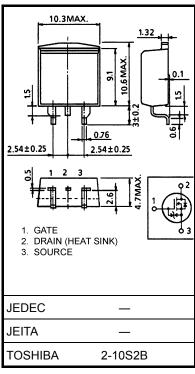
Note 2: $V_{DD} = 90~V,~T_{ch} = 25^{\circ}C$ (initial), L = 4.41 mH, R_G = 25 Ω , $I_{AR} = 10~A$

Note 3: Repetitive rating: Pulse width limited by maximum channel temperature

This transistor is an electrostatic-sensitive device. Please handle with caution.



Weight: 1.5 g (typ.)



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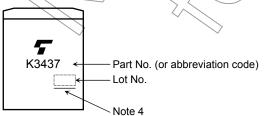
Electrical Characteristics (Ta = 25°C)

Chara	acteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Gate leakage cur	rent	I _{GSS}	$V_{GS} = \pm 25 \text{ V}, V_{DS} = 0 \text{ V}$	_	_	±10	μА
Gate-source brea	kdown voltage	V (BR) GSS	$I_G=\pm 10~\mu A,~V_{DS}=0~V$	±30	_	_	V
Drain cut-off curre	ent	I _{DSS}	V _{DS} = 600 V, V _{GS} = 0 V	/	_	100	μА
Drain-source brea	akdown voltage	V (BR) DSS	$I_D = 10$ mA, $V_{GS} = 0$ V	600	_	_	V
Gate threshold vo	oltage	V _{th}	V _{DS} = 10 V, I _D = 1 mA	3.0) / _	5.0	V
Drain-source ON-	-resistance	R _{DS} (ON)	V _{GS} = 10 V, I _D = 5 A	\nearrow	0.74	1.0	Ω
Forward transfer	admittance	Y _{fs}	V _{DS} = 15 V, I _D = 5 A	2.0	4.5	_	S
Input capacitance	;	C _{iss}		_	1200	_	
Reverse transfer capacitance		C _{rss}	V _{DS} = 25 V, V _{GS} = 0 V, f = 1 MHz	² —	10	_	pF
Output capacitance		Coss		_	130	_	
Switching time Fa	Rise time	t _r	, 10 V , 10 7 9 A Vouт	- (13	>	
	Turn-on time	t _{on}	VGS OV		40) —	ns
	Fall time	t _f	V _{DD} ≈ 300 V	7	8	_	
	Turn-off time	t _{off}	Duty ≤ 1%, t _W = 10 μs) –	50		
Total gate charge (gate-source plus		Qg		_	28	_	
Gate-source char	ge	Q _{g\$}	$V_{DD} \approx 400 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 10 \text{ A}$	_	16	_	nC
Gate-drain ("mille	r") charge	Q _{gd}		_	12	_	

Source-Drain Ratings and Characteristics (Ta = 25°C)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Continuous drain reverse current (Note 1)	I _{DR}		_	_	10	Α
Pulse drain reverse current (Note 1)	IDRP	_	_	_	30	Α
Forward voltage (diode)	VDSF	I _{DR} = 10 A, V _{GS} = 0 V	_	_	-1.7	V
Reverse recovery time	t _{rr}	I _{DR} = 10 A, V _{GS} = 0 V,	_	1600	_	ns
Reverse recovery charge	Qrr	dl _{DR} /dt = 100 A/μs	_	17	_	μС



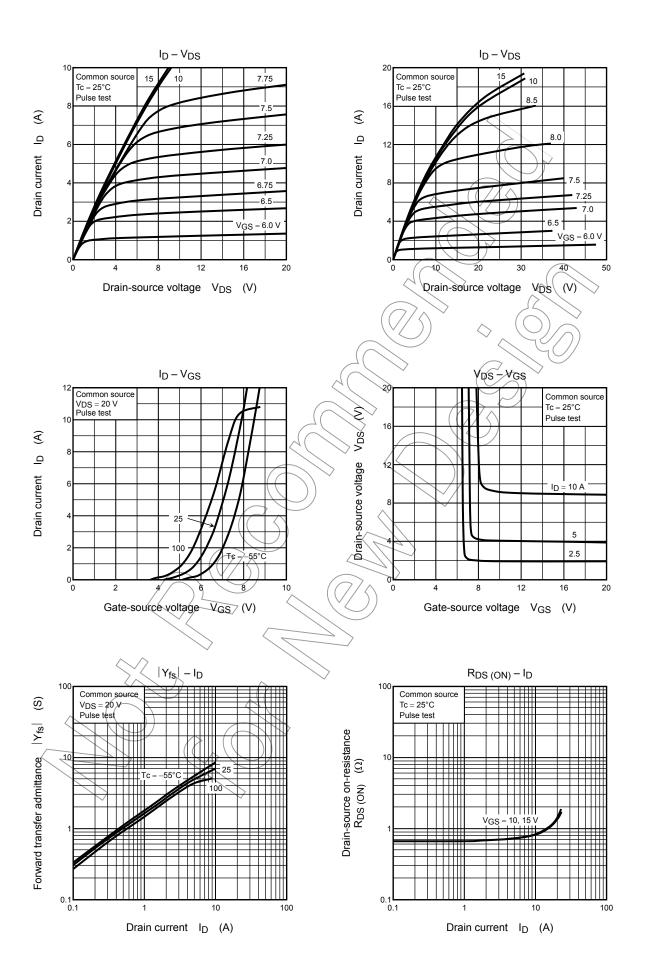


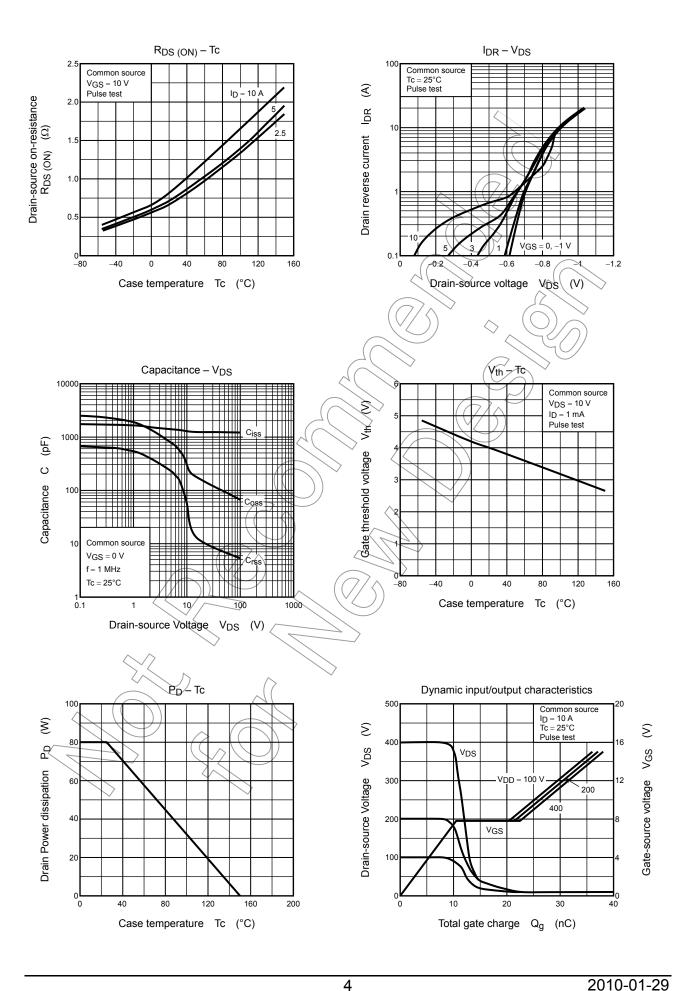
Note 4: A line under a Lot No. identifies the indication of product Labels.

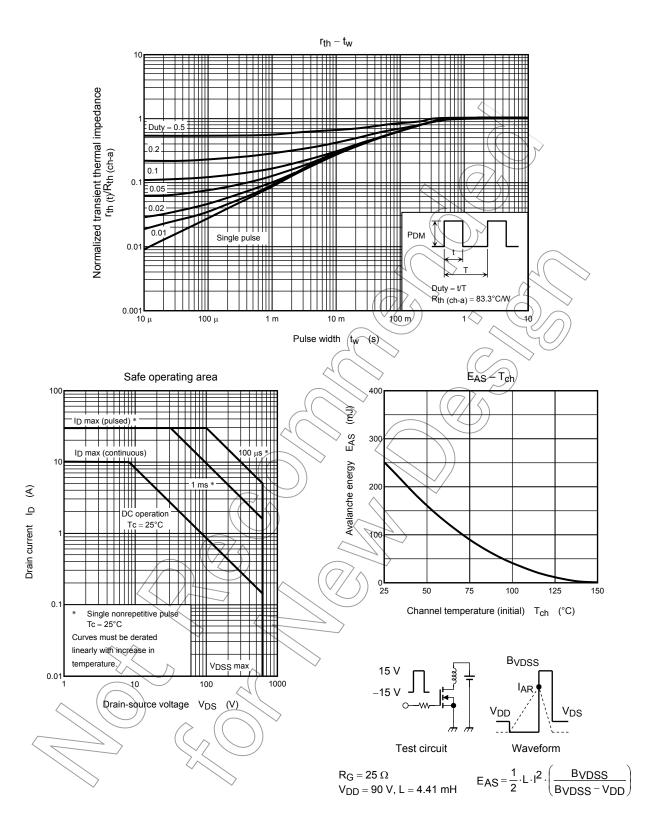
Not underlined: [[Pb]]/INCLUDES > MCV

Underlined: [[G]]/RoHS COMPATIBLE or [[G]]/RoHS [[Pb]]

Please contact your TOSHIBA sales representative for details as to environmental matters such as the RoHS compatibility of Product. The RoHS is the Directive 2002/95/EC of the European Parliament and of the Council of 27 January 2003 on the restriction of the use of certain hazardous substances in electrical and electronic equipment.







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